Supplementary Materials



Figure S1. The copper oxide deposition system based on the magnetron sputtering technology.



Figure S2. The titanium dioxide deposition system based on the magnetron sputtering technology.

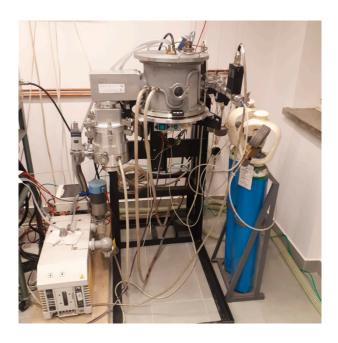


Figure S3. Tin dioxide deposition system based on the magnetron sputtering technology